

Data Sheet FUJITSU Mainboard Accessories

SMARTCASE™ S710 Chassis Kit Solution AMD

Desigend for AMD mini-ITX D3313-S

Industrial chassis for enhanced operating temperature range. Usable in horizontal and vertical mode

Supported Mainboards:

D3313-S1 (GX-210HA SOC – 2x 1.0GHz/9W) Dual Core D3313-S2 (GX-217GA SOC – 2x 1.65GHz/15W) Dual Core D3313-S3 (GX-420CA SOC – 4x 2.00GHz/25W) Quad Core D3313-S4 (GX-222GC SOC – 2.20GHz/10-15W) Dual Core D3313-S5 (GX-412HC SOC – 1.20GHz/5-7W) Quad Core D3313-S6 (GX-424CC SOC – 2.40GHz/25W) Quad Core Data Sheet

Approvals & Certifications:

Mainboard D3313-S certified for MS Windows 7 & Windows 8.1 System unit approved according CE EMC regulations System unit approved for enhanced temperature range

Product Features:

HDD/system fan (4 pin PWM) included
SATA data cable and power cable included
Chassis desk stand (horizontal/vertical, removable) included
Chassis wall mount included
Chassis intrusion support
Kensington lock support
Mechanical lock for DC-in power connector
Mounting option for 2.5" HDD
Mounting option for WLAN antenna via (RP-)SMA connector
Mounting option for PCI / PCIe riser (low profile)
Mounting option for additional serial port

Order Code:

S26361-F5000-J002 (10 pcs)



(Chassis with desk stand)



(Chassis with wall mount)

Features and benefits

Chassis

Size 250 x 52 x 191 mm (w x h x d)

Colour anthracite
Weight ~ 1kg

Operating Conditions

Approved operating temperature range

D3313-S1:

fanless, horizontal or vertical mode 0°C – 35°C 1)

D3313-S1 / S2 / S4:

Heatsink with heatpipe, fanless $0^{\circ}\text{C} - 35^{\circ}\text{C}^{1)}$

horizontal or vertical mode

D3313-S1 / S2 / S3 / S4 / S5:

CPU fan + HDD fan

horizontal or vertical mode 0°C – 50°C 1)

D3313-S5:

fanless, horizontal or vertical mode 0°C – 40°C 1)

1) = Chassis ambient temperature

Humidity

5% - 85% relative humidity (non-condensing)

HDD fan specification

PWM (4 pin), 40 x 40 x 10mm

1750 - 5.500 rpm (nominal)

Two ball bearing

Operating temperature range: -10°C - 70°C

MTBF: 70.000 hours @ 40°C

Note: HDD fan not required for D3313-S1 with passive heatsink

and D3313-S2 with heatpipe-heatsink ($T_{Ambient} \le +35^{\circ}C$)

Package content

Chassis bottom/top incl. front bezel; I/O with integrated EMI gasket

HDD carrier incl. 4 pin PWM fan

Riser card holder incl. power button / power LED and intrusion switch

HDD SATA cable and power cable for one drive(length = 250 mm each)

Optional Accessories

Passive heatsink (9W) S26361-F5000-C006

Passive heatsink with heatpipe (15W) S26361-F5000-C007

Active heatsink with fan (25W) S26361-F5000-C005

Note: All heatsinks incl. backplate

Additional serial port cable (AZR:AW-NU224) S26361-F5000-K005

Drive Power Cable (HDD + DVD slim) S26361-F5000-K001

1x PCle riser card D3318 (for D3313-S) S26361-F5000-R006

DP to DVI adapter cable S26361-F5000-A003

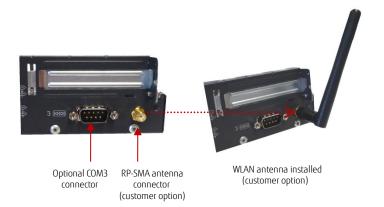
DVI-I to VGA Adapter S26361-F5000-A001

TPM Module V1.2 (Infineon D3127) S26361-F5000-R005

Internal PSU Module 12V/65W S26361-F5000-P004

(Note: Requires AMD kit solution ≥ Rev. 06)





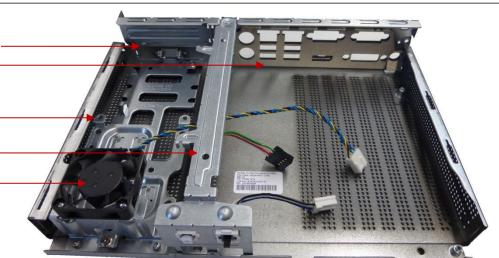
Features and benefits

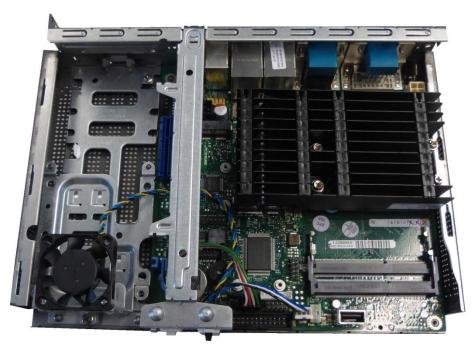
Aperture for additional serial port and WLAN (RP-) SMA connector (Ø 7.2mm)
Integrated EMI gasket

Mounting space for 2.5" HDD

Riser card holder with integrated power button (illuminated) and chassis intrusion switch

Integrated HDD / system fan





Chassis with mainboard D3313-S and passive 15W heatsink (with heatpipe)



Aperture for DisplayPort with removable cover.
Note: Cover required for D3003-S1/S3

Chassis rear view

Aperture for optional COM3 connector with removable cover (metal clip) Aperture for optional (RP-) SMA antenna connector with removable cover (Ø 7.2mm)



Passive Mini-ITX Heatsink AMD for Industrial Mainboards D3313-S1

Passive Heatsink Kit for Mini-ITX mainboards – designed for fanless chassis solutions for AMD embedded G-Series SoC (D3313-S1)

Heatsink F5000-C006:

Full aluminum

Spring-loaded mounting screws for specified downforce Recommended mounting screw torque = 0.6Nm

Order Code:

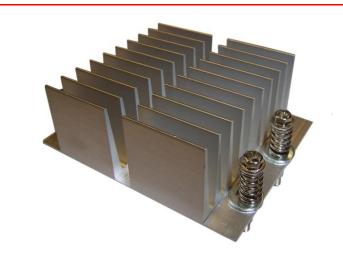
S26361-F5000-C006 (backplate included)

Backplate:

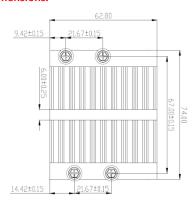
Metal backplate, provides 4 mounting threads for heatsink

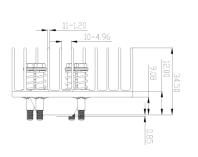
Supported processors:

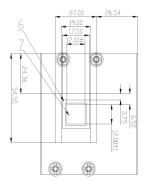
D3313-S1: AMD GX-210HA SOC (1GHz DualCore / 9W)



Dimensions:









(insulating foil resp. insulating plate)
V26898-B883-V100 (alternative backplates) V26898-B883-V10

Important Note:

Insulating foil of backplate –B883-V100 must NOT be removed, otherwise mainboard may be damaged due to possible shortcut





Passive Mini-ITX Heatsink with Heatpipe AMD for Industrial Mainboard D3313-S1/S2/S4 (@ cTDP=15W)/S5

Passive Heatsink with Heatpipe Kit for Mini-ITX mainboards – designed for fanless chassis solutions for AMD embedded G-Series SoC (D3313-S1/S2/S4/S5)

Heatsink F5000-C006:

Full aluminum

Spring-loaded mounting screws for specified downforce Recommended mounting screw torque = 0.6Nm

Order Code:

S26361-F5000-C007 (backplate included)

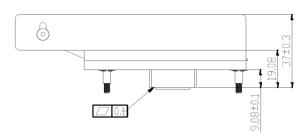
Backplate:

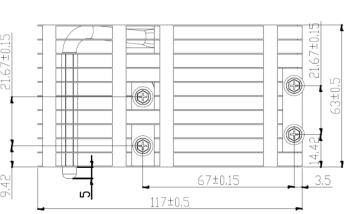
Metal backplate, provides 4 mounting threads for heatsink

Supported processors:

D3313-S1 (GX-210HA SOC – 2x 1.0GHz/9W) Dual Core D3313-S2 (GX-217GA SOC – 2x 1.65GHz/15W) Dual Core D3313-S4 (GX-222GC SOC – 2.20GHz/10-15W) Dual Core D3313-S5 (GX-412HC SOC – 1.20GHz/5-7W) Quad Core

Dimensions:









(insulating foil resp. insulating plate)
V26898-B883-V100 (alternative backplates) V26898-B883-V10

Important Note:

Insulating foil of backplate –B883-V100 must NOT be removed, otherwise mainboard may be damaged due to possible shortcut.



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Mini-ITX Heatsink AMD for Industrial Mainboards D3313-S

Active Heatsink for mini-ITX mainboard – designed for silent but effective cooling for AMD embedded G-Series APU / embedded G-Series SoC processors up to 25W TDP

Heatsink F5000-C005:

Full aluminum incl. metal backplate Spring-loaded mounting screws for specified downforce Weight: 160g

Order Code:

S26361-F5000-C005 (backplate included)

Integrated Fan:

Fan: $60 \times 60 \times 15.5$ mm, 12 VDC, dual ball bearing Power consumption: max. 0.46A @ 100% PWM duty cycle

Speed: 900 rpm - 6.000 rpm (nom. speed)

Sound level: 49.2 dB(A) max.

Operating temperature range: -10°C - 70°C

MTBF: 70.000 hrs @ 40°C

Supported Processors:

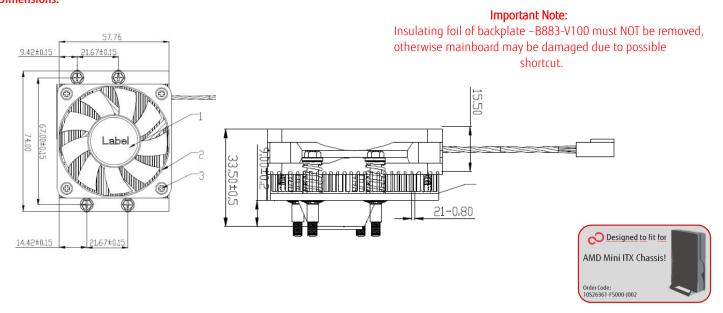
All AMD embedded G-Series / G-Series SoC processors up to 25W TDP

Heatsink Mounting:

Recommended mounting screw torque = 0.6Nm



Dimensions:



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Fujitsu Risercard for mini-ITX Mainboards

PCI & PCIe Risercards for using PCIe extension cards on mini-ITX boards D3313-S

Usability:

Enables the use of extension cards Flexible operation of mini-ITX Boards

Reliability:

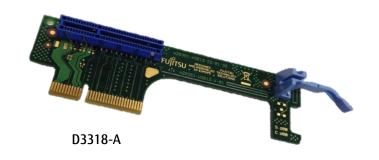
Performance in PCI and PCIe standard
Designed for 24/7 operation
Designed for extended temperature range up to 60°C

Approvals

CE

Order Code:

S26361-F5000-R006 (D3318-A)







TMP Module D3127-A

Optional TPM V1.2 (Infineon) module for D3313-S

Usability:

Easy and secure upgrade for D3313-S with TPM V1.2 for enhanced security applications

Reliability:

Designed for 24/7 operation

Approvals

CE

Order Code:

S26361-F5000-R5 (D3127-A)

Package Content:

TPM module

Mounting kit (nondetachable screw)

Note: No software included

Driver Support

TPM V1.2 driver support is included in MS Windows 7 / Windows 8.1

Software Support

Infineon TPM Professional Package is available here:

http://support.ts.fujitsu.com/Download/ShowDescription.asp?SoftwareGUID=1C4FA7B0-173C-44F2-8210-8B523194FB48&Info=FTS&Inq=DE



D3127-A





19V/65W AC-Adapter - S26361-F5000-P3

Suitable for Mainboards D3313-Sx / D3474-B

Supported Mainboards:

D3313-S1/S2/S3 (AMD eKabini) D3313-S4/S5/S6 (AMD SteppeEagle) D3474-B (Intel, H110, LGA1151)

Product Features:

Input: 100-240V Output: 19V / 3.42A

Operating conditions

Temperature range 0°C - 40°C Humidity 10% - 90% relative

Approvals

CE, FCC, UL, CCC, TÜV/GS, PSE, ECA

Reliability

MFBF > 20.000 h

AC Input Voltage

Nominal input voltage range 100V - 240V Min/max input voltage range 90V - 264V Line frequency $50Hz / 60Hz \pm 5\%$ Max total harmonic distortion of input voltage 5% Input hold up time nominal load @ 115/230V ≥ 5ms

Main DC Outputs

65W Output power 19V Nominal voltage Regulation tolerance ± 5% Min. current 0A Continuous current 3.42A Ripple and noise (bandwidth limit of 20MHz) 300mV Max. recovery time < 1ms Max. step load ΔI 1.95A LPS (limited power source) Yes



AC Input:



Order Code:

S26361-F5000-P3

Contains AC adapter (w/o mains power cable)





Data Sheet

Fujitsu Mainboard Accessories

12V Internal PSU E598-V50

Suitable for Industrial Mainboards D3313-S / D3543-S / D3433-S / D3434-S

Supported Mainboards (Chassis Kit Solutions)

D3313-S

D3433-S (support for E598 planned) D3434-S (support for E598 planned)

D3543-S (support for E598 planned)

Product Features

Input: 100-240V ~ 1.5A 50-60Hz

Output: 12V / 5.4A

Operating conditions

Temperature range 0°C - 50°C with nominal load Humidity 5% - 85% relative

Approvals

CE; CCSAUS or CULUS; NEMKO; BSMI-RoHS; CCC; KC

Reliability

MTBF (MIL 217F) > 100.000 h (25°C)

AC Input Voltage

Nominal input voltage range 100V - 240V Min/max input voltage range 90V - 264V Line frequency 47Hz - 63Hz Max total harmonic distortion of input voltage $\leq 5\%$ Input hold up time nominal load @230V50Hz $\geq 16ms$

Main DC Outputs

Output power	65W
Nominal voltage	12V
Regulation tolerance	± 5%
Min. current	0A
Ripple and noise (bandwidth limit of 20MHz)	120mV
Max. step load ΔI	3.3A
LPS (limited power source)	Yes





Order Code

S26361-F5000-P4 includes

- Internal PSU module E598-V50
- Internal DC cable for D3313-S kit solution (T26139-Y4030-V10; 320mm)
- Internal DC cable for D3543-S kit solution (T26139-Y4030-V9; 110mm)

Mains power cable is NOT included!

Efficiency

% of nominal load	Efficiency @230V
5%	>80%
10%	>84%
20%	>87%
50%	>90%
100%	>87%

Connector Details

Mains Input Socket: IEC 60320/C8



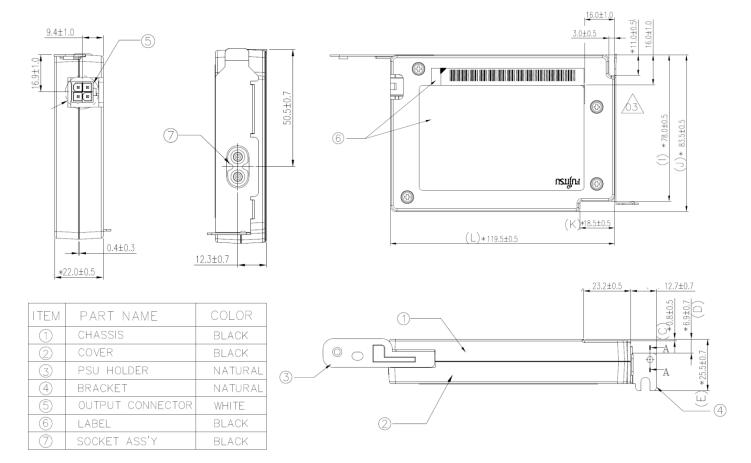
100-240V AC

12V DC Output Socket: Molex 4-Pin



Pin 1/2	GND
Pin 3/4	12V

Mechanical Dimensions



More information

Fujitsu products, solutions & services

Products

www.fujitsu.com/global/products/ In addition to the Fujitsu [Product name], Fujitsu offers a full portfolio of other computing products.

Computing products

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- Client Computing Devices: LIFEBOOK, STYLISTIC, ESPRIMO, FUTRO, CELSIUS
- Peripherals: Fujitsu Displays, Accessories
- Software
- Network

Product Support Services with different service levels agreements are recommended to safeguard each product and ensure smooth IT operation.

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business environment.

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Business Services respond to the challenge of planning, delivering and operating IT in a complex and changing IT environment.

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Fujitsu green policy innovation

www.fujitsu.com/global/about/environment/ Fujitsu Green Policy Innovation is our worldwide project for reducing burdens on the environment. Using our global know-how, we aim to resolve issues of environmental energy efficiency through IT. Please find further information at:



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